	Type	L#	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	7671	(257/79,94,99,103,276,625,712). CCLS.	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:39
2	BRS	L2	172007	("light emitting device" "light emitting diode")	US-PGPUB; USPAT; JPO; DERWENT	2007/04/19 14:39
3	BRS	L3	3946	1 and L2	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:39
4	BRS	L4	125	3 and "sapphire substrate" with (cavity "through hole" via depression hole)	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:45
5	BRS	L5	43	4 and @ad<"20011002"	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:52
6	BRS	L6	8	5 and ("heat sink" "thermal conductive" ((radiation radiating) adj heat))	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:52
7	BRS	L7	320	2 and "sapphire substrate" with (cavity "through hole" via depression hole)	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:45
8	BRS	L8	92	7 and @ad<"20011002"	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:52
9	BRS	L9	18	8 and ("heat sink" "thermal conductive" ((radiation radiating) adj heat))	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 14:52

	Type	L#	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	4380	(438/22,24,46,47,122,540).CCLS	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2007/04/19 16:01
2	BRS	L2	44	1 and "sapphire substrate" with (cavity "through hole" hole depression recess)	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
3	BRS	L3	18		US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
4	BRS	L4	7	conductive" ((radiation radiating)	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
5	BRS	L5	265	"through hole" hole depression	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
6	BRS	L6	172007	("light emitting device" "light	US-PGPUB; USPAT; JPO; DERWENT	2007/04/19 16:05
7	BRS	L7	152	5 and L6	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
8	BRS	L8	52	7 and @ad<"20011002"	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05
9	BRS	L9	15	conductive" ((radiation radiating)	US-PGPUB; USPAT; EPO; DERWENT	2007/04/19 16:05